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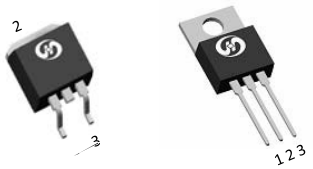
, - I H NSJ ·) GΩ

- GEH H CGN

=E A CGN



LN(OG L =E A LECHA

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(- .) (-

M FON RCG OG , NCHAM N. □=25 (unless otherwise specified)

L G NL - SG I F □ H CNCHM 0 FO HCN

□ HNGHCJ OM L CH□OLL HN - GEH H CGN . □=25

L CHN - I CL= 0I FN A 0 _

N N - I CL= 0I FN A 0 _ j 0

G . □=25 G

I Q L CMCJ NCH . □=25 W

) J L NCHA H - NL A . GJ L NCL . . MA N

M FON RCG OG , NCHAM

L G NL - SG I F HCN

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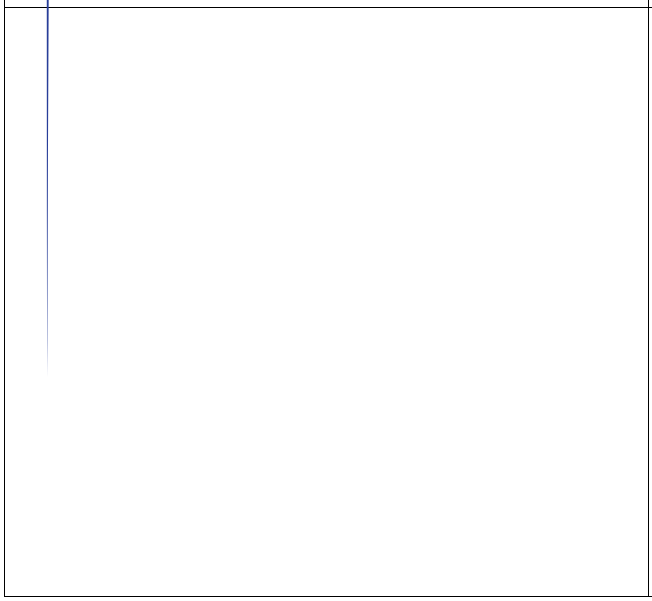
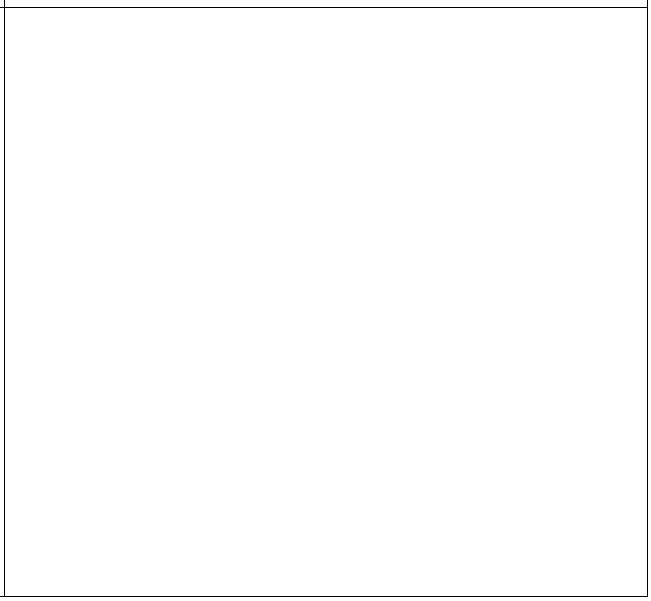
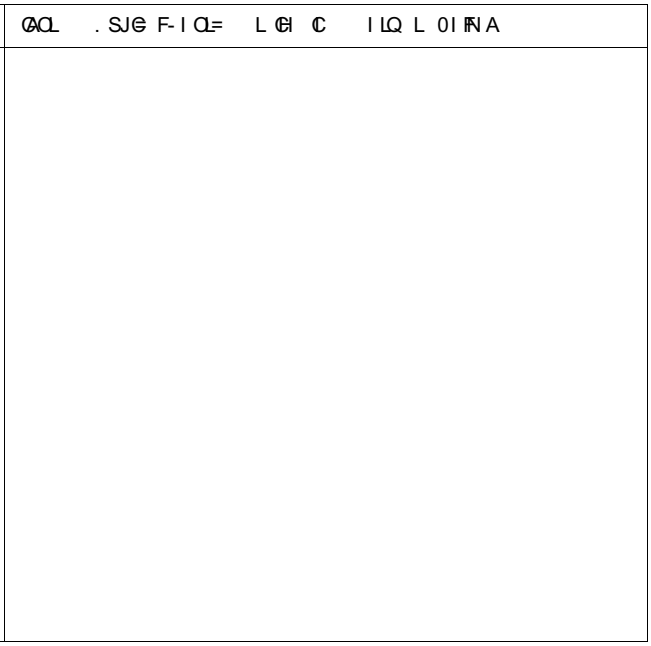
L CHN -I CL= IH, MCNH= , -IH 0 -

	
	Figure 4. Normalized On-Resistance vs. Junction Temperature
Figure 5. Typical Transfer Characteristics	

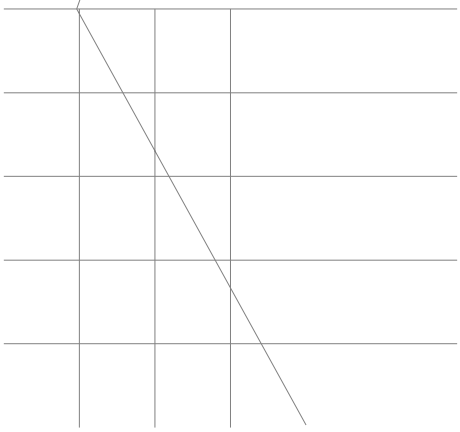


Figure 9. Maximum Safe Operating Area	
Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case	

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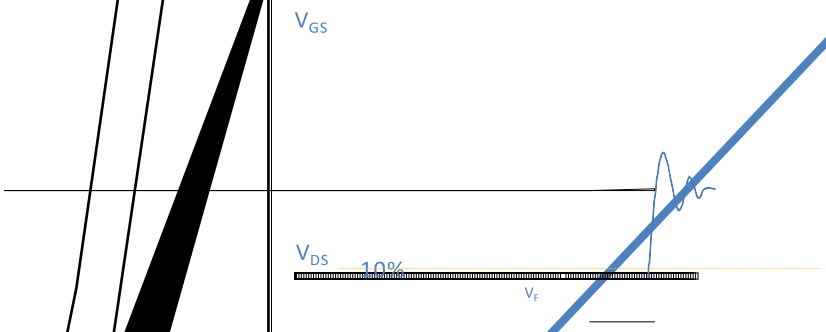
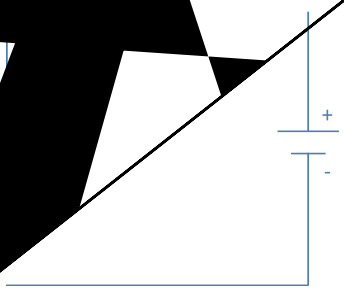
H C=NC MQQC=BCIA. MN



N □B LA . MN

=F GJ H C=NC - QC=BCIA - . MN



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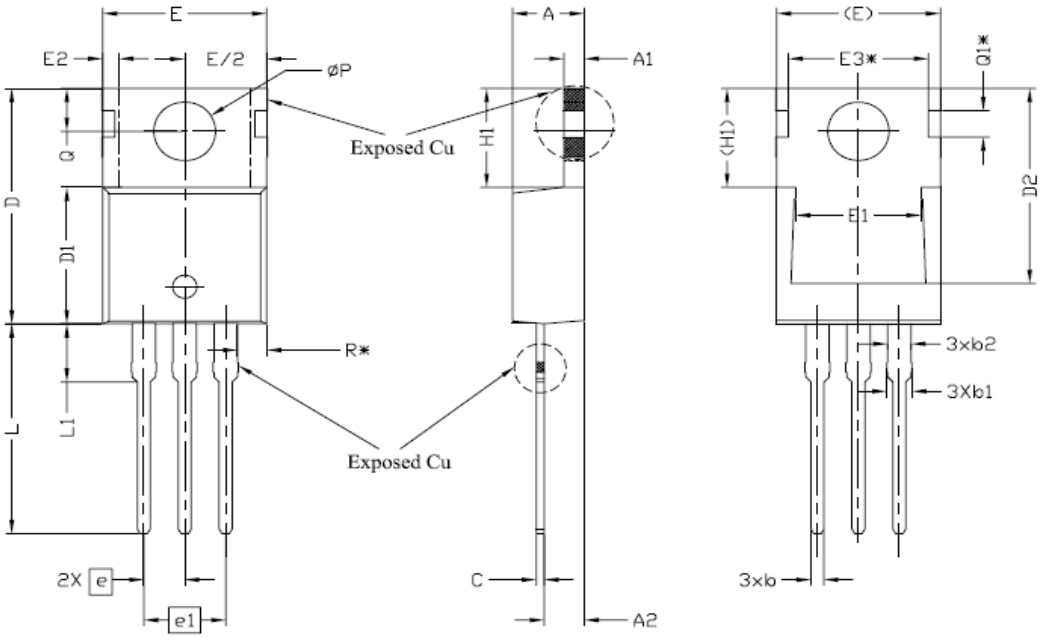

SYMBOL	DIMENSIONS			NOTES
	MIN.	NOM.	MAX.	
A	4,24	4,44	4,64	
A1	1,15	1,27	1,40	
A2	2,30	2,48	2,70	
b	0,70	0,80	0,90	
b1	1,20	1,55	1,75	
b2	1,20	1,45	1,70	
c	0,40	0,50	0,60	
D	14,70	15,37	16,00	4
D1	8,82	8,92	9,02	
D2	12,63	12,73	12,83	5
E	9,96	10,16	10,36	4,5
E1	6,86	7,77	8,89	5
E2	-	-	0,76	6
E3*	8,70REF.			
e	2,54BSC			
e1	5,08BSC			
H1	6,30	6,45	6,60	5,6
L	13,47	13,72	13,97	
L1	3,60	3,80	4,00	
øP	3,75	3,84	3,93	
Q	2,60	2,80	3,00	
Q1*	1,73REF.			
R*	1,82REF.			

=E A) ONKCI

.) F M